Embedded AI

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Message from the Guest Editors

This Special Issue aims to present the latest research results and developments in the field of embedded AI. All researchers in this field are invited to submit their original work in research and review formats.

Topics of interest include, but are not limited to:

- Algorithms for embedded AI;
- TinyML;
- Digital hardware for FPGAs or ASICS;
- Analog circuits for AI;
- Massively parallel AI for GPUs;
- AI engines;
- Reservoir computing for AI.

Special Issue

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Message from the Editor-in-Chief

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